

**MECHANICAL DATA** 

Module dimension

Viewing area

Active area

Dot size

Dot pitch

Mounting hole

ITEM

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#### **FEATURES**

- Type: graphic
- Display format: 128 x 64 dots
- Built-in controller: SSD1325
- Duty cycle: 1/64
- +3 V power supply
- Interface: 6800, 8080, and serial
- With polarizer
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

			ABSOLUTE MAX	IMUM R	ATINGS	
	UNIT	1	ITEM SYMBOL		STANDAF	RD VALUE
		1		STWIDOL	MIN.	MAX.
	- mm	Supply voltage for logic <sup>(1)(2)</sup>	V <sub>DD</sub>	-0.3	4	
			Supply voltage for display <sup>(1)(2)</sup>	V <sub>CC</sub>	0	15
	_		Operating temperature	T <sub>OP</sub>	-40	+80
		İ	Storage temperature	T <sub>STG</sub>	-40	+80

#### Notes

- $^{(1)}\,$  All the above voltages are on the basis of "V\_{SS} = 0 V".
- <sup>(2)</sup> When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

ELECTRICAL CHARACTERISTICS								
ITEM	SYMBOL	CONDITION	ST	ANDARD VA	LUE	UNIT		
	STWBOL	CONDITION	MIN.	TYP.	MAX.			
Supply voltage for logic	V <sub>DD</sub>	-	2.8	3.0	3.3			
Supply voltage for display	V <sub>CC</sub>	-	10	12	15			
Input high voltage	V <sub>IH</sub>	-	0.8 V <sub>DD</sub>	-	V <sub>DD</sub>	v		
Input low voltage	V <sub>IL</sub>	-	0	-	0.2 V <sub>DD</sub>	v		
Output high voltage	V <sub>OH</sub>	-	0.9 V <sub>DD</sub>	-	V <sub>DD</sub>			
Output low voltage	V <sub>OL</sub>	-	0	-	0.1 V <sub>DD</sub>			
50 % check board operating current	I <sub>CC</sub>	$V_{CC} = 12 V$	26	28	32	mA		

OPTION	OPTIONS									
	EN	IITTING COLO	OR		MOQ					
YELLOW	GREEN	RED	BLUE	WHITE	YELLOW	GREEN	RED	BLUE	WHITE	
Yes	-	-	-	-	Yes	-	-	-	-	



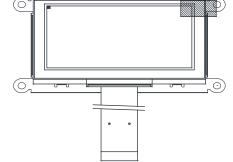
RoHS

COMPLIANT

UNIT

V

°C



STANDARD VALUE

89.7 x 47.2 x 3.4

63.41 x 32.69

61.41 x 30.69

0.45 x 0.45

0.48 x 0.48

n/a



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INTER	FACE PIN	I FUNCT	TION						
PIN NO.	SYMBOL	1/0		FUNC	TION				
1	NC (GND)		Reserved pin (supporting pin) The supporting pin can reduce the influences from stresses on the function pins. This pin must be connected to external ground.						
2	V <sub>CC</sub>	Р	Power supply for OLED p This is the most positive v	anel /oltage supply pin of the c	hip. It must be supplied ex	ternally.			
3	V <sub>COMH</sub>	Ρ	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. It can be supplied externally or internally. When $V_{COMH}$ is generated internally, a capacitor should be connected between this pin and $V_{SS}$ .						
4	I <sub>REF</sub>	I		Current reference for brightness adjustment This pin is segment current reference pin. A resistor should be connected between this pin and V <sub>SS</sub> .					
5 to 12	D7 to D0	1/0		rectional data bus to be c	connected to the microproc put SDIN and D0 will be the				
13	E / RD#	Ι	as the enable (E) signal. F	input. When interfacing to Read / write operation is in ting to an 80XX microproc	a 68XX-series microproces nitiated when this pin is pul sessor, this pin receives the w and CS# is pulled low.	lled high and the CS# is			
14	R / W#	I	as read / write (R / W#) se	input. When interfacing to lection input. Pull this pin ce mode is selected, this p	a 68XX-series microproces to "high" for read mode and in will be the write (WR#) inp is pulled low.	d pull it to "low" for write			
15	D / C#	I	Data / command control This pin is data / command control pin. When the pin is pulled high, the input at D7 to D0 is treated as display data. When the pin is pulled low, the input at D7 to D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the timing characteristics diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register.						
16	RES#	Ι	Power reset for controller and driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.						
17	CS#	I	Chip select This pin is the chip select low.	input. The chip is enabled	d for MCU communication of	only when CS# is pulled			
18	NC		Reserved pin The NC pins between fun	ction pins are reserved fo	r compatible and flexible de	esign.			
19	BS2		Communicating protocol These pins are MCU inter		the following table:				
		1		68XX parallel	80XX parallel	Serial			
			BS1	0	1	0			
20	BS1		BS2	1	1	0			
5 to 12	D7 to D0	1/0		rectional data bus to be c	connected to the microproc out SDIN and D0 will be the				
21	V <sub>DD</sub>	Р	Power supply for logic cir This is a voltage supply p	cuit					
22	NC		0 1771						
23	NC		1						
24	NC		1						
25	NC		Reserved pin		a second the second first state	:			
26	NC		I ne NC pins between fun	ction pins are reserved for	r compatible and flexible de	esign.			
27	NC		4						
28	NC		-						
29	V <sub>SS</sub>	Р	Ground of OLED system This is a ground pin. It als analog circuits. It must be		the logic pins, the OLED d	Iriving voltages, and the			

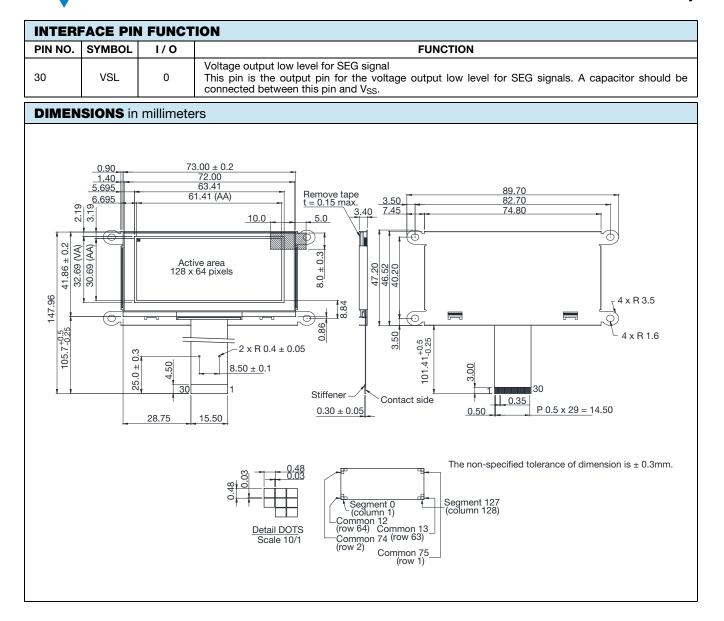
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## OLED-128Y064L-LPP3N00000

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# **1.Module Classification Information**

OLED	128	Υ	06	4 L	L	Ρ	Ρ	3	Ν	0	0	000
0	Ø	٩	٩	5	Ô	Ō	٢	9	10	(11)	12	13
1	Brand:	Visha	ay Inte	technol	ogy, Ir	IC.	•		•		•	· · ·
2	Horizon	tal Fo	rmat: 1	28 Colu	mns							
3	Display	Туре:	N→0	Characte	er Typ	e, F	l→Gra	aphic	Туре,	Y-	→Tab	Туре,
4	Vertical	Forma	at: 64 L	ines.								
5	Serials	code										
				A : Amb	-				: REI			
6	Emitting			B : Blue				_	: Full		•	
0		, 00101		G : Gre					/:Wh			
				Y:Yello	ow Gre	een		L	: Yello	SW		
7	Polarize	er		P∶With	Pola	rizer; I	I: Wit	hout F	Polariz	er		
8	Display	Мос	le	P : Passive Matrix ; A: Active Matrix								
9	Driver V	/oltage	<b>;</b>	3: 3.0 V	5: 5.0	)V						
10	Touch F	Panel		N∶With	out to	uch p	anel; <sup>-</sup>	T: With	n touc	h pan	el	
				0 : Stan	dard t	уре						
				1. Sunlight Readable type								
11	Product	s type		2. Transparent OLED (TOLED)								
				3. Flexible OLED								
				4. OLED for Lighting								
				product g	rades:							
				0 : Standard(A-level)								
40	Duada	-1	-	2 : B-level								
12	Produ	ci grad	les	3 : C-level								
				4 : high class(AA-level)								
				5 : Customer offerings								
13	Serial N	lo.		Applicatio	on seria	al numl	per(00	0~ZZ	Z)			



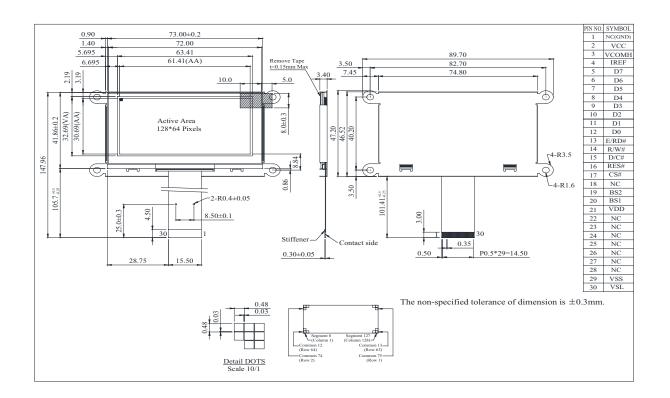
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# **2.General Specification**

ltem	Dimension	Unit
Dot Matrix	128 x 64	_
Module dimension	89.7 × 47.2 × 3.4 (mm)	mm
Active Area	61.41 × 30.69 (mm)	mm
Pixel Size	0.45 × 0.45 (mm)	mm
Pixel Pitch	0.48 × 0.48 (mm)	mm
Display Mode	Passive Matrix	
Display Color	Monochrome (Yellow)	
Drive Duty	1/64 Duty	

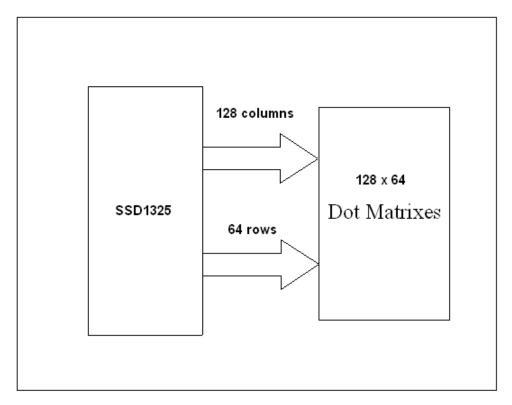


# 3. Counter Drawing & Block Diagram





#### FUNCTION BLOCK DIAGRAM



\*For more information, please refer to Application Note provided by Vishay

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# **4. Interface Pin Function**

No.	Symbol	I/O	Function
1	NC(GND)		Reserved Pin (Supporting Pin) The supporting pin can reduce the influences from stresses on the function pins. This pin must be connected to external ground.
2	VCC	Р	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip. It must be supplied externally.
3	VCOMH	Р	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. It can be supplied externally or internally. When VCOMH is generated internally, a capacitor should be connected between this pin and VSS.
4	IREF	Ι	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at $10\mu$ A.
5~12	D7~D0	I/O	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK
13	E/RD#	Ι	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
14	R/W#	Ι	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
15	D/C#	Ι	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be



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	1	-						
			transferred to the command register. For detail					
			relationship to MCU interface signals, please refer to					
			the Timing Characteristics Diagrams					
			Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is					
			selected, the data at SDIN is treated as data. When it is					
			pulled low, the data at SDIN will be transferred to the					
			command register.					
			Power Reset for Controller and Driver					
16	RES#	Ι	This pin is reset signal input. When the pin is low,					
		_	initialization of the chip is executed.					
			Chip Select					
17	CS#	Ι	This pin is the chip select input. The chip is enabled for					
			MCU communication only when CS# is pulled low.					
			Reserved Pin					
18	NC		The N.C. pins between function pins are reserved for					
			compatible and flexible design.					
			Communicating Protocol Select					
19	BS2		These pins are MCU interface selection input. See the					
		I	following table:					
		1	68XX-parallel 80XX-parallel Serial					
20	BS1		BS1 0 1 0					
			BS2 1 1 0					
			Power Supply for Logic Circuit					
21	Vdd	Р	This is a voltage supply pin. It must be connected to					
22	NC		external source.					
22	NC		_					
23	NC							
24	NC		Reserved Pin					
25 26	NC NC		The N.C. pins between function pins are reserved for compatible and flexible design.					
20								
27	NC NC		_					
28	INC		Crowned of OLED System					
			Ground of OLED System					
29	Vss	Р	This is a ground pin. It also acts as a reference for the					
			logic pins, the OLED driving voltages, and the analog circuits. It must be connected to external ground.					
			Voltage Output Low Level for SEG Signal					
			This pin is the output pin for the voltage output low					
30	VSL	0	level for SEG signals. A capacitor should be connected					
			between this pin and VSS.					
			between this pin and visis.					



# **5.Absolute Maximum Ratings**

Parameter	Symbol	Min	Мах	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	-
Storage Temperature	TSTG	-40	+80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate



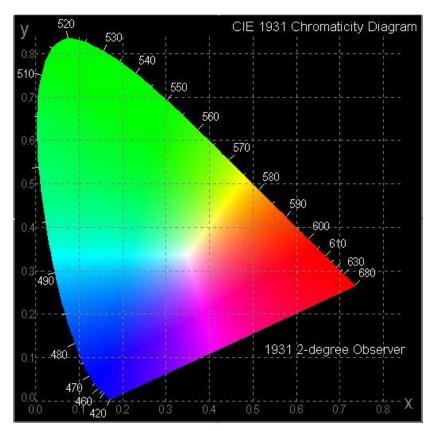
# **6.Electrical Characteristics**

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	—	10	12	15	V
High Level Input	VIH	_	0.8×V <sub>DD</sub>	_	V <sub>DD</sub>	V
Low Level Input	VIL	_	0	_	0.2×V <sub>DD</sub>	V
High Level Output	VOH	_	0.9×V <sub>DD</sub>	_	Vdd	V
Low Level Output	VOL	_	0	_	0.1×V <sub>DD</sub>	V
50% Check Board operatir Current	ng	VCC =12 V	26	28	32	mA



# **7.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Мах	Unit
View Angle	θ(V)		160			deg
view / angle	(H)φ		160			deg
Contrast Ratio	CR	Dark	2000:1			-
Response Time	T rise	—		10		μs
	T fall	_		10		μs
Display with 50% check	Board Brig	ghtness	60	80		cd/m2
CIEx(Yellow)		(CIE1931)	0.45	0.47	0.49	
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52	



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## **8.OLED** Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	80,000 Hrs	100,000 Hrs	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



# 9.Reliability

#### Content of Reliability Test

Environmenta	Environmental Test					
Test Item	Content of Test	Test Condition	Applicable Standard			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 °C 240hrs				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80 °C 240hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40 °C 240hrs				
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90% RH 240hrs				
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40 30min 5min 30min 1 cycle	-40 °C ⁄80°C 100 cycles				
Mechanical Te	st					
/ibration test Endurance test applying the vibration during transportation and using.		10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr				
Shock test	Constructional and mechanical endurance test applying the shock during transportation.					
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs				
Others						
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time				

\*\*\* Supply voltage for OLED system =Operating voltage at  $25^{\circ}$ C



#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





# **10.Inspection specification**

NO	Item	Criterion					AQL
01	Electrical	1.1 Missing vertical, horizontal segment, segment contrast			/ loc		
	Testing	defect.					
	_	1.2 Missing character , dot or icon.					
		1.3 Display malf					
		1.4 No function					0.65
		1.5 Current cons				becifications.	
		1.6 OLED viewing angle defect.					
		1.7 Mixed product types. 1.8 Contrast defect.					
			000				
02	Black or	2.1 White and bl	ack spots	on c	lisplay <u>≦</u> 0.25n	nm, no more than	
	white	three white or bl		•			
	spots on	2.2 Densely spa	ced: No m	ore	than two spots	s or lines within	2.5
	OLED	3mm.					
	(display only)						
03	OLED	3.1 Round type	: As				
	black	following drawin			SIZE	Acceptable Q	
	spots,	Φ=( x + y ) / 2	-			TY	
	white	X			Ф≦0.10	Accept no	
	spots,	│ ─ <b>⋗</b> 」 <del>●</del> ─ <u>↓</u>	_			dense	2.5
	contamina tion	• -	Y		0.10<	2	2.5
	(non-displ	l T	•		Φ≦0.20	4	
	ay)				0.20<	1	
	57				Φ≦0.25	-	
			A . C. II		0.25<Φ	0	
		3.2 Line type : (A		<u> </u>	awing) dth	Accortable O TV	
		<b>Y</b> 317	Length		⊴0.02	Acceptable Q TY Accept no dense	
			   < 3 0	_	$\ge 0.02$ $02 < W \le 0.03$	Accept no dense	2.5
		→ <sub>L</sub> +			$0.03 < W \le 0.05$	2	
			L <u>≥</u> 2.5	_	)5 <w 05<w< td=""><td></td><td></td></w<></w 		
				0.0	55 < VV	As round type	
04	Polarizer	lf hubbles are '	aible				
	bubbles	If bubbles are vis			ze Φ < 0.00	Acceptable Q TY	
		specifications, n		-	≦0.20	Accept no dense	
		to find, must check in 0.5		$20 < \Phi \le 0.50$	3	2.5	
					$50 < \Phi \le 1.00$	2	
					$00 < \Phi$	0	
				10	tal Q TY	3	

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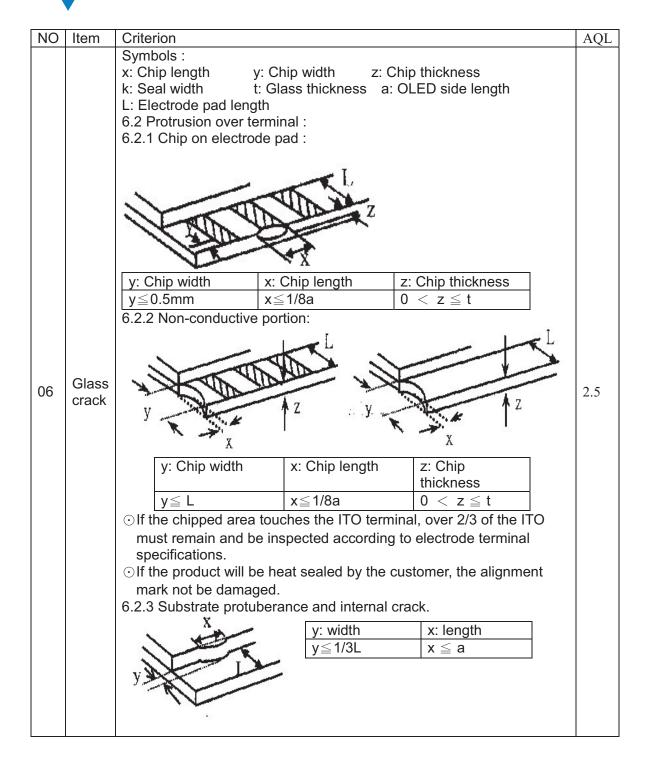
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
			t: Glass thickness a:	Chip thickness : OLED side length	
		<ul> <li>6.1 General glass chip :</li> <li>6.1.1 Chip on panel surface and crack between panels:</li> </ul>			
				y i war	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
<ul> <li>⊙ If there are 2 or more chips, x is total length of each chip</li> <li>6.1.2 Corner crack:</li> </ul>					
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≦1/8a	
		$1/2t < z \le 2t$	Not exceed 1/3k	x≦1/8a	
$\odot$ If there are 2 or more chips, x is the total length of each chip				l length of each chip.	

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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB、COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> </ul>	<ol> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>2.5</li> <li>0.65</li> <li>0.65</li> <li>2.5</li> </ol>
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65



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NO	Item	Criterion	AQL
NO	Item	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5
12	General appearance	interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or	2.5 2.5
		chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened.	0.65 0.65
		12.7 Sealant of top of the fro circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	



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Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel

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# **11.Precautions in use of OLED Modules**

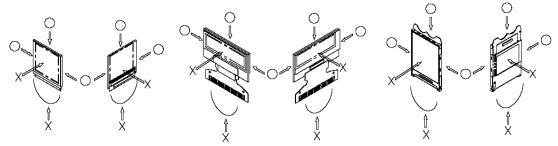
## Modules

- (1)Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) Vishay has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version.)
- 11.1. Handling Precautions
- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent
  - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent
  - such as ethyl alcohol, since the surface of the polarizer will become cloudy.
  - Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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(7) Do not apply stress to the LSI chips and the surrounding molded sections.

(8) Do not disassemble nor modify the OLED display module.

(9) Do not apply input signals while the logic power is off.

(10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.

- \* Be sure to make human body grounding when handling OLED display modules.
- \* Be sure to ground tools to use or assembly such as soldering irons.
- \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

\* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

(11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### **11.2. Storage Precautions**

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Vishay Intertechnology, Inc.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### **11.3. Designing Precautions**

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power

circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

(5) As for EMI, take necessary measures on the equipment side basically.



(6) When fastening the OLED display module, fasten the external plastic housing section.(7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

\* Connection (contact) to any other potential than the above may lead to rupture of the IC.11.4.

#### Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### 11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- \* Pins and electrodes
- \* Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- \* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- \* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.



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